Introduction to Semiconductor Packaging
EEL 4930  Section XXXX

Class Periods:  Days of week, period, and corresponding time of day
Location:  Classroom location
Academic Term:  Spring 2024

Instructor:
• Name:  Dr. Navid Asadizanjani
• Email Address:  nasadi@ufl.edu
• Office Phone Number:  352-294-1075
• Office Hours:  TBD
• TA:  TBD
• Office hours:  TBD

Teaching Assistant/Peer Mentor/Supervised Teaching Student:
Please contact through the Canvas website
• Name, email address, office location, office hours
• Name, email address, office location, office hours

Course Description
Focuses on Fundamentals of Semiconductor Packaging including materials and substrates and assembly processes involved in advanced packaging, testing and reliability of Advanced Packaging and uses in current industry Lecture. Credits 3.

Course Pre-Requisites / Co-Requisites
- EEL 3008 (C)

Course Objectives
• The focus of this course is to first address the fundamentals of semiconductor packaging evolution, current technology, and future developments in advanced semiconductor packaging. More than ten modules will be discussed in this course to cover all topics of this aspect.

• In addition, this course provides an in-depth and intriguing overview of the dynamic world of advanced packaging, including topics such as package assembly, interconnects, substrates, and advanced packaging materials.

• This course delves into the influence of advanced packaging on contemporary semiconductor devices.

• This course also highlights testing and reliability aspects of advanced semiconductor packaging. Along with Thermal Management aspects involved in advanced packaging.

• Furthermore, this course will introduce the opportunities and challenges and provide a clear direction of the requirements for advanced packaging and its uses in the current industry.
Materials and Supply Fees
N/A

Relation to Program Outcomes (ABET):
The table below is an example. Please consult with your department’s ABET coordinator when filling this out.

<table>
<thead>
<tr>
<th>Outcome</th>
<th>Coverage</th>
</tr>
</thead>
<tbody>
<tr>
<td>1. An ability to identify, formulate, and solve complex engineering problems by applying principles of engineering, science, and mathematics</td>
<td>Medium</td>
</tr>
<tr>
<td>2. An ability to apply engineering design to produce solutions that meet specified needs with consideration of public health, safety, and welfare, as well as global, cultural, social, environmental, and economic factors</td>
<td>High</td>
</tr>
<tr>
<td>3. An ability to communicate effectively with a range of audiences</td>
<td></td>
</tr>
<tr>
<td>4. An ability to recognize ethical and professional responsibilities in engineering situations and make informed judgments, which must consider the impact of engineering solutions in global, economic, environmental, and societal contexts</td>
<td>Medium</td>
</tr>
<tr>
<td>5. An ability to function effectively on a team whose members together provide leadership, create a collaborative and inclusive environment, establish goals, plan tasks, and meet objectives</td>
<td></td>
</tr>
<tr>
<td>6. An ability to develop and conduct appropriate experimentation, analyze and interpret data, and use engineering judgment to draw conclusions</td>
<td></td>
</tr>
<tr>
<td>7. An ability to acquire and apply new knowledge as needed, using appropriate learning strategies</td>
<td>Medium</td>
</tr>
</tbody>
</table>

*Coverage is given as high, medium, or low. An empty box indicates that this outcome is not covered or assessed in the course.

Required Textbooks and Software
- Course lectures and notes are developed by the instructor.
- Semiconductor Advanced Packaging by John H. Lau

Recommended Materials
- Title
- Author
- Publication date and edition
- ISBN number

Course Schedule
<table>
<thead>
<tr>
<th>Week</th>
<th>Topics</th>
<th>Description</th>
</tr>
</thead>
</table>
| 1    | Introduction to IC Packaging | • Definition of packaging and its significance in various industries.  
• Introduction to packaging and its importance in Modern Electronics.  
• Provide an overview of the course structure and learning objectives. |
| 2    | Traditional Packaging Technologies I | • Exploring different packaging technologies, such as leaded and leadless packages, surface mount technology (SMT), and ball grid array (BGA). |
| 3    | Traditional Packaging Technologies II | • Discussion on the purpose and characteristics of each technology.  
• Explanation of the factors influencing technology selection |
| 4    | Introduction to Advanced Packaging I | • Definition of advanced packaging and its importance in meeting evolving technology requirements. |
| 5    | Introduction to Advanced Packaging II | • Explaining the benefits and challenges associated with advanced packaging.  
• Exploring different integrated technology of advanced packaging technologies, such as 2.5D, 3D packaging, |
| 6    | Advanced Packaging Interconnects I | • Discussion on interconnect technologies used in advanced packaging, such as flip chip bumping, solder balls, and through-silicon vias (TSVs), photonic integration. |
| 7    | Advanced Packaging Interconnects II | • Explanation of the working principles and considerations for each interconnect technology.  
• Highlight their impact on electrical performance and signal integrity. |

**MID TERM EXAMINATION**

<table>
<thead>
<tr>
<th>Week</th>
<th>Topics</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>8</td>
<td>Advanced Packaging Materials and Substrates I</td>
<td>• Detail the substrates and materials used in advanced packaging, such as organic substrates, build-up substrates, and redistribution layers (RDLs), interposers, fan-out substrate.</td>
</tr>
</tbody>
</table>
| 9    | Advanced Packaging Materials and Substrates II | • Explaining substrates and materials, their properties, fabrication techniques, and performance characteristics.  
• Discussion on the selection criteria for different advanced packaging applications. |
| 10   | Thermal Management in Advanced Packaging I | • Introduction to the importance of thermal management in advanced packaging. |
| 11   | Thermal Management in Advanced Packaging II | • Discussion on various thermal management techniques, such as heat sinks, thermal interface materials (TIMs), and thermal vias.  
• Explanation of the design considerations for effective thermal management. |
| 12   | Testing and Reliability in Advanced Packaging I | • The testing methodologies and reliability considerations specific to advanced packaging.  
• Discussion on package-level testing, interconnect testing, and reliability testing. |
Testing and Reliability in Advanced Packaging II

- Explanation of various failure analysis techniques and strategies for ensuring package reliability.

Future Trends and Emerging Technologies

- Discussion on emerging trends in advanced packaging and their potential impact
- Insights into future developments and opportunities in the field.

Final presentations and reports due

Final exam (cumulative)

---

**Attendance Policy, Class Expectations, and Make-Up Policy**

Requirements for class attendance and make-up exams, assignments, and other work in this course are consistent with university policies. Click here to read the university attendance policies: [https://catalog.ufl.edu/UGRD/academic-regulations/attendance-policies/](https://catalog.ufl.edu/UGRD/academic-regulations/attendance-policies/)

**Evaluation of Grades**

<table>
<thead>
<tr>
<th>Assignment</th>
<th>Percentage of Final Grade</th>
</tr>
</thead>
<tbody>
<tr>
<td>Homework</td>
<td>20%</td>
</tr>
<tr>
<td>Midterm Exam</td>
<td>25%</td>
</tr>
<tr>
<td>Final Presentation</td>
<td>30%</td>
</tr>
<tr>
<td>Final Exam</td>
<td>25%</td>
</tr>
<tr>
<td><strong>Total</strong></td>
<td><strong>100%</strong></td>
</tr>
</tbody>
</table>

This course is co-listed with the graduate version. The homework portion for graduate and undergraduate sections will involve different weights and problems. There will be more advanced concepts for the graduate section. The exams will also involve additional questions for the graduate section with respect to the undergraduate section. Grading for the presentations is different for the undergraduate course. Graduate presentations will include an additional discussion section for challenges in various packaging types and structures.

**Grading Policy**

The following is given as an example only.

<table>
<thead>
<tr>
<th>Percent</th>
<th>Grade</th>
<th>Grade Points</th>
</tr>
</thead>
<tbody>
<tr>
<td>93.4 - 100</td>
<td>A</td>
<td>4.00</td>
</tr>
<tr>
<td>90.0 - 93.3</td>
<td>A-</td>
<td>3.67</td>
</tr>
<tr>
<td>86.7 - 89.9</td>
<td>B+</td>
<td>3.33</td>
</tr>
<tr>
<td>83.4 - 86.6</td>
<td>B</td>
<td>3.00</td>
</tr>
<tr>
<td>80.0 - 83.3</td>
<td>B-</td>
<td>2.67</td>
</tr>
<tr>
<td>76.7 - 79.9</td>
<td>C+</td>
<td>2.33</td>
</tr>
<tr>
<td>73.4 - 76.6</td>
<td>C</td>
<td>2.00</td>
</tr>
<tr>
<td>70.0 - 73.3</td>
<td>C-</td>
<td>1.67</td>
</tr>
<tr>
<td>66.7 - 69.9</td>
<td>D+</td>
<td>1.33</td>
</tr>
<tr>
<td>63.4 - 66.6</td>
<td>D</td>
<td>1.00</td>
</tr>
<tr>
<td>60.0 - 63.3</td>
<td>D-</td>
<td>0.67</td>
</tr>
<tr>
<td>0 - 59.9</td>
<td>E</td>
<td>0.00</td>
</tr>
</tbody>
</table>
More information on UF grading policy may be found at: https://catalog.ufl.edu/ugrad/current/regulations/info/grades.aspx

**Students Requiring Accommodations**

Students with disabilities who experience learning barriers and would like to request academic accommodations should connect with the disability Resource Center by visiting https://disability.ufl.edu/students/get-started/. It is important for students to share their accommodation letter with their instructor and discuss their access needs, as early as possible in the semester.

**Course Evaluation**

Students are expected to provide professional and respectful feedback on the quality of instruction in this course by completing course evaluations online via GatorEvals. Guidance on how to give feedback in a professional and respectful manner is available at https://gatorevals.aa.ufl.edu/students/. Students will be notified when the evaluation period opens, and can complete evaluations through the email they receive from GatorEvals, in their Canvas course menu under GatorEvals, or via https://ufl.bluera.com/ufl/. Summaries of course evaluation results are available to students at https://gatorevals.aa.ufl.edu/public-results/.

**In-Class Recording**

Students are allowed to record video or audio of class lectures. However, the purposes for which these recordings may be used are strictly controlled. The only allowable purposes are (1) for personal educational use, (2) in connection with a complaint to the university, or (3) as evidence in, or in preparation for, a criminal or civil proceeding. All other purposes are prohibited. Specifically, students may not publish recorded lectures without the written consent of the instructor.

A “class lecture” is an educational presentation intended to inform or teach enrolled students about a particular subject, including any instructor-led discussions that form part of the presentation, and delivered by any instructor hired or appointed by the University, or by a guest instructor, as part of a University of Florida course. A class lecture does not include lab sessions, student presentations, clinical presentations such as patient history, academic exercises involving solely student participation, assessments (quizzes, tests, exams), field trips, private conversations between students in the class or between a student and the faculty or lecturer during a class session.

Publication without permission of the instructor is prohibited. To “publish” means to share, transmit, circulate, distribute, or provide access to a recording, regardless of format or medium, to another person (or persons), including but not limited to another student within the same class section. Additionally, a recording, or transcript of a recording, is considered published if it is posted on or uploaded to, in whole or in part, any media platform, including but not limited to social media, book, magazine, newspaper, leaflet, or third party note/tutoring services. A student who publishes a recording without written consent may be subject to a civil cause of action instituted by a person injured by the publication and/or discipline under UF Regulation 4.040 Student Honor Code and Student Conduct Code.

**University Honesty Policy**

UF students are bound by The Honor Pledge which states, "We, the members of the University of Florida community, pledge to hold ourselves and our peers to the highest standards of honor and integrity by abiding by the Honor Code. On all work submitted for credit by students at the University of Florida, the following pledge is either required or implied: “On my honor, I have neither given nor received unauthorized aid in doing this assignment.” The Honor Code (https://sccr.dso.ufl.edu/process/student-conduct-code/) specifies a number of behaviors that are in violation of this code and the possible sanctions. Furthermore, you are obligated to report any condition that facilitates academic misconduct to appropriate personnel. If you have any questions or concerns, please consult with the instructor or TAs in this class.
Commitment to a Safe and Inclusive Learning Environment
The Herbert Wertheim College of Engineering values varied perspectives and lived experiences within our community and is committed to supporting the University’s core values, including the elimination of discrimination. It is expected that every person in this class will treat one another with dignity and respect regardless of race, creed, color, religion, age, disability, sex, sexual orientation, gender identity and expression, marital status, national origin, political opinions or affiliations, genetic information, and veteran status.

If you feel like your performance in class is being impacted by discrimination or harassment of any kind, please contact your instructor or any of the following:
• Your academic advisor or Graduate Program Coordinator
• HWCOE Human Resources, 352-392-0904, student-support-hr@eng.ufl.edu
• Curtis Taylor, Associate Dean of Student Affairs, 352-392-2177, taylor@eng.ufl.edu
• Toshikazu Nishida, Associate Dean of Academic Affairs, 352-392-0943, nishida@eng.ufl.edu

Software Use
All faculty, staff, and students of the University are required and expected to obey the laws and legal agreements governing software use. Failure to do so can lead to monetary damages and/or criminal penalties for the individual violator. Because such violations are also against University policies and rules, disciplinary action will be taken as appropriate. We, the members of the University of Florida community, pledge to uphold ourselves and our peers to the highest standards of honesty and integrity.

Student Privacy
There are federal laws protecting your privacy with regards to grades earned in courses and on individual assignments. For more information, please see: https://registrar.ufl.edu/ferpa.html

Campus Resources:

Health and Wellness

U Matter, We Care:
Your well-being is important to the University of Florida. The U Matter, We Care initiative is committed to creating a culture of care on our campus by encouraging members of our community to look out for one another and to reach out for help if a member of our community is in need. If you or a friend is in distress, please contact umatter@ufl.edu so that the U Matter, We Care Team can reach out to the student in distress. A nighttime and weekend crisis counselor is available by phone at 352-392-1575. The U Matter, We Care Team can help connect students to the many other helping resources available including, but not limited to, Victim Advocates, Housing staff, and the Counseling and Wellness Center. Please remember that asking for help is a sign of strength. In case of emergency, call 9-1-1.

Counseling and Wellness Center: https://counseling.ufl.edu, and 392-1575; and the University Police Department: 392-1111 or 9-1-1 for emergencies.

Sexual Discrimination, Harassment, Assault, or Violence
If you or a friend has been subjected to sexual discrimination, sexual harassment, sexual assault, or violence contact the Office of Title IX Compliance, located at Yon Hall Room 427, 1908 Stadium Road, (352) 273-1094, title-ix@ufl.edu

Sexual Assault Recovery Services (SARS)
Student Health Care Center, 392-1161.

University Police Department at 392-1111 (or 9-1-1 for emergencies), or http://www.police.ufl.edu/.

Academic Resources
E-learning technical support, 352-392-4357 (select option 2) or e-mail to Learning-support@ufl.edu. [https://lss.at.ufl.edu/help.shtml](https://lss.at.ufl.edu/help.shtml).

Career Connections Center, Reitz Union, 392-1601. Career assistance and counseling; [https://career.ufl.edu](https://career.ufl.edu).

Library Support, [http://cms.uflib.ufl.edu/ask](http://cms.uflib.ufl.edu/ask). Various ways to receive assistance with respect to using the libraries or finding resources.

Teaching Center, Broward Hall, 392-2010 or 392-6420. General study skills and tutoring. [https://teachingcenter.ufl.edu/](https://teachingcenter.ufl.edu/).

Writing Studio, 302 Tigert Hall, 846-1138. Help brainstorming, formatting, and writing papers. [https://writing.ufl.edu/writing-studio/](https://writing.ufl.edu/writing-studio/).
